

IN THE SPECIFICATION

Please delete the paragraph beginning on page 6, line 18, and ending at line 24 and replace it with the following amended paragraph:

Figure 3 is a cross-section view of endshield 102 and illustrates an inner surface 154 that includes a substantially flat raised portion 156. Raised portion 156 is located directly beneath recessed fins 132 and is a component of a thermal pathway between transistors 110 (not shown in Figure 3) and recessed fins 132. Recessed fins 132 extend from raised portion ~~154~~ 156 to increase the surface area of outer surface 130 which facilitates the dissipation of heat from endshield 102. Raised cylinder 150 and bold opening 152 are also illustrated in Figure 3.